SiW ECAL optimization study

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Outline -ILD simulation-

SiW ECAL Simulation with model ILD detector(DBD version)
Dead area from guard ring width

Energy correction by direction for photon
PCB (Printed Circuit Board) thickness
Dead channels effect

ILD detector -Particle Flow Algorithm(PFA)-

ILD is optimized for PFA in hadronic jets. PFA does calorimeter tracking and separates each particle cluster, and identify whether the particle is charged, neutral hadron or photon.

Particle in jet
 Charged particle (65 %)→TPC
 Photon (25 %) →ECAL
 Neutral hadron (10 %) →HCAL





ECAL structure in ILD

- Sandwich calorimeter with **tungsten absorber** and **Silicon sensor** or **scintillator and MPPC** for detector.
- Tungsten absorber for **short radiation length** X₀ (0.35 cm), **small Molière radius**(0.93 cm) and **large ratio of interaction length to radiation length**(27.4).
- For PFA, **high granularity is required for good separation of clusters.** The segmentation is **5 mm × 5 mm**.
- ECAL has 30 layers, equivalent to about $24X_0$.

About guard ring in Si sensor

- Sensor is matrix of PIN diodes.
- Guard ring prevents surface leakage current. Thus it decreases noise and keeps the dynamic range. It also extends depletion layer. guard ring



Sensor for ILD. guard ring-induced dead area width: 0.5 mm(default

SiECAL structure



• Study how thin guard ring(=dead area) is required.

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• We will have guard ring effect particularly in vertical direction to the beam pipe.



Energy correction for photon

- Energy decreases in central guard ring, alveolar structure, module end and barrel end cap gap.
- Direction resolution for θ is 3.3 × 10⁻⁴ rad.
 It's sufficient to give a correction by θ.
- Upper graph can be fitted by linear and Gaussian functions.



Energy correction function

- These functions are obtained by fitting10 GeV photon energy measurement.
- Larger guard ring has larger effect.



Jet Energy Resolution (JER) evaluation

- We use "Z→uu/dd/ss" events
 - Z decayed at rest, avoid barrel/endcap overlap region.

• Tails

- Confusion is significant
- RMS over-emphasizes the tails

• RMS90

 Defined as the RMS in the smallest range of reconstructed energy which contains 90 % of the events



RMS90 is calculated using events in this 90 % area

JER with different guard ring width

the benchmark resolution for good separation between W and Z boson hadronic decay

- RMS90 increases as guard ring width increase.
- About 6 % difference between 0 mm and 2 mm.
- Direction correction has small effect on RMS90.



PCB (Printed Circuit Board) thickness effect

- As we have many channels in ECAL, we put PCB in each layer to combine signals (serialize) and reduce number of readout cables.
- Thick PCB will increase lateral shower size. So thin PCB maybe preferred.
- However, too thin PCB is technologically difficult and expensive.

Chips and bonded wires inside the PCB



JER dependence on PCB thickness

O.4 mm increase
 →0.014X₀ / layer increase.

total ECAL radiation length increase by 0.42X₀.

- No significant dependence is seen.
- With thicker PCB, ECAL, HCAL and coil also become larger.

the benchmark resolution for good separation between W and Z boson hadronic decay



Dead channels effect

- If a few % dead cell is OK, we can increase yield for Si sensor and reduce cost.
- Some of the readout chip may broken down during construction or experiment.
- How to study dead channel and chip effect:



JER dependence on dead pixels / chips fraction



• Small effect under 15 % pixels

ECAL resolution is sensitive to dead channels but JER is basically limited by HCAL resolution.

> Effective granularity is sufficient for PFA.

• As dead chip fraction increases, JER increases linearly.

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Modeling of photon energy resolution dependence on dead fraction (ξ)

• $\frac{\sigma_E}{E} = b_0(\xi) \bigoplus \frac{b_1(\xi)}{\sqrt{E}} = \text{const.} \oplus \text{stochastic}$

Const. term is from non-uniformity (= dead fraction)



• Most of photons in the jets have low E (\leq 3 GeV) →Little contribution by const. term(=dead fraction)

Summary

- SiW ECAL for ILD optimization of guard ring width, PCB thickness and dead pixel(chip) was studied.
- Jet energy resolution(JER) increases as guard ring width increase. The difference between 0 mm and 2 mm is about 6 %.
- With different PCB thickness, no significant JER change was seen.
- 15 % of dead channels have very little effect on JER.
- JER increases as dead chip fraction increase.

Back up

Dead pixel rate – Number of ECAL hit

• ECAL hits decreases with dead pixel rate



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Photon shower shape in ECAL



















Photon Energy fraction in a jet



■ 20%~30% on average (large fluctuation by events)

Energy of a photon pfo in a jet



■ Mostly under 2~3GeV

Soft photon PFOs give the dominant contribution to neutral energy in a jet The energy resolution is determined mainly by stochastic term

Simple estimation of JER

$$\sigma_j \sim \sqrt{N_c \sigma_c^2 + N_\gamma \sigma_\gamma^2 + N_h \sigma_h^2}$$

$$\sim \sqrt{N_\gamma \sigma_\gamma^2 + N_h \sigma_h^2} \qquad \sigma_h \sim 0.55 \sqrt{E_h (\text{GeV})}$$

Assume a typical 45 GeV jet

$$N_{\gamma} = 9, N_{h}=2,$$

 $E_{\gamma}=1.4$ GeV, $E_{h} = 3.0$ GeV
(See later slides)

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$$\begin{aligned}
\text{(pixel)} & (\leftarrow \text{fit with plots in page7} \rightarrow) \text{ (chip)} \\
b_0^2(\xi) + \left(\frac{b_1(\xi)}{\sqrt{E_\gamma}}\right)^2 & b_0(\xi) = 1.6 (1 + 12\xi) (\%) & b_0(\xi) = 1.6 (1 + 28\xi) (\%) \\
b_1(\xi) = \frac{17.4}{\sqrt{1 - \xi}} (\%) & b_1(\xi) = \frac{17.4}{\sqrt{1 - 1.5\xi}} (\%)
\end{aligned}$$

5% dead	σ _γ /Ε (%)	σ _j /E _j (%)
ріх	15.6	3.50
chip	16.5	3.55
10% dead	σ _r /Ε (%)	σ _j /E _j (%)
10% dead pix	σ _r /E (%) 16.5	σ _j /E _j (%) 3.55

20% dead	σ _γ /Ε (%)	σ _j /E _j (%)
pix	18.6	3.70
chip	24.3	4.13
30% dead	σ _r /Ε (%)	σ _j /E _j (%)
30% dead pix	σ _r /E (%) 21.2	σ _j /E _j (%) 3.89

Error bar of JER in simulation (1000 events) \sim 0.2-0.3 % for each point